

Features:

- 1.Low power consumption.
- 2. High efficiency and low cost.
- 3. Good control and free combinations on the colors of LED lamps.
- 4. Good lock and easy to assembly.
- 5. Stackable and easy to assembly.
- 6. Stackable vertically and easy to assembly.
- 7. Versatile mounting on P.C board or panel.
- 8. Stackable horizontally and easy to assembly.
- 9. The product itself will remain within RoHS compliant version.

Descriptions:

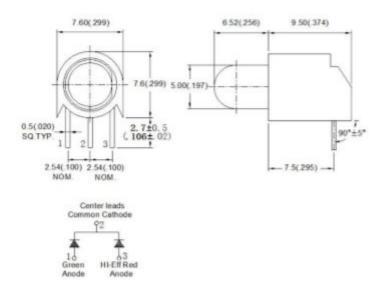
- **1.**ARRAY=Plastic Holder + Combinations of Lamps.
- **2.**The array will easily mount be applicable on any panel up to.

Applications:

- 1. TV set.
- 2. Monitor.
- 3. Telephone.
- 4. Computer.
- 5. Circuit board, etc.

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◆ Package Dimension:



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (0.01") unless otherwise specified.
- Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

Part No.	Chip Material		Lens Color	Source Color
DL-H59RGMA-C	R	AlGaInP	White Diffused	Hyper Red
	G	GaP	white billused	Yellow Green

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♦ Absolute Maximum Ratings at Ta=25°C

Parameters		Symbol	Max.	Unit	
Power Dissipation	Hyper Red	DD.	80		
	Yellow Green	PD	80	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse	IFP	100	mA		
Forward Current	Hyper Red	IF	25	mA	
	Yellow Green	IF	25	mA	
Reverse Voltage	VR	5	V		
Electrostatic Discharge (HBM)	Hyper Red	ECD.	2000	V	
	Yellow Green	ESD	2000	V	
Operating Temperature Range		Topr	-40°C to +85°C		
Storage Temperature Range		Tstg	-40°C to +100°C		
Lead Soldering Temperature [4mm (.157") From Body]		Tsld	260°C for 5 Seconds		

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♦ Electrical Optical Characteristics at Ta=25 °C

Parameters	Symbol	Emitting Color	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity *	IV	Hyper Red	100	200		mcd	IF=20mA (Note 1)
	IV	Yellow Green	50	100			
Viewing Angle *	2θ _{1/2}	Hyper Red		60		Deg	IF=20mA (Note 2)
		Yellow Green		60	1		
Peak Emission Wavelength	λр	Hyper Red		632		nm	IF=20mA
		Yellow Green		572	-		
Dominant Wavelength	λd	Hyper Red		624	1	nm	IF=20mA (Note 3)
		Yellow Green		575			
Spectral Line Half-Width	Δλ	Hyper Red		20		nm	IF=20mA
		Yellow Green		15			
Forward Voltage	VF	Hyper Red	1.80	2.20	2.80	V	IF=20mA
		Yellow Green	1.80	2.20	2.80		
Reverse Current	IR	Hyper Red			10	μΑ	V _R =5V
		Yellow Green			10		

Notes:

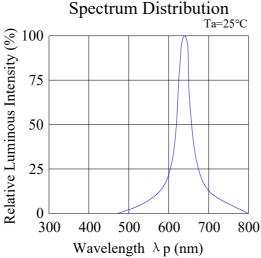
- 1. Luminous Intensity Measurement allowance is ± 10%.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength (λ d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

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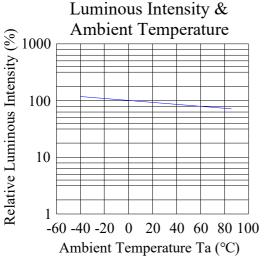
Typical Electrical / Optical Characteristics Curves

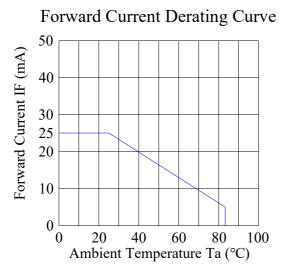
(25°C Ambient Temperature Unless Otherwise Noted)

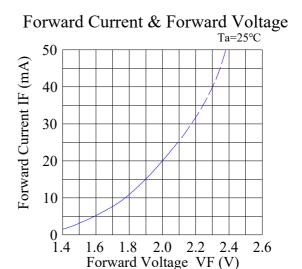
Hyper Red:

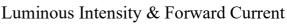


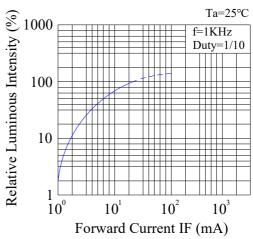
800

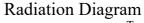


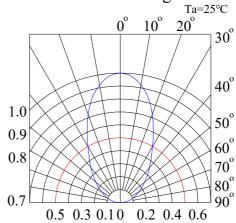






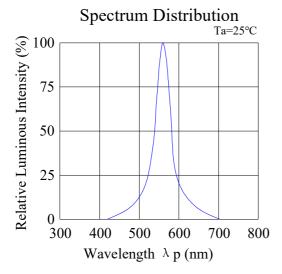




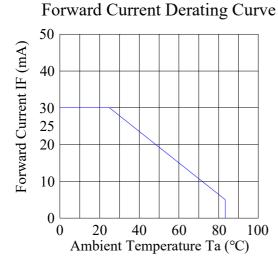


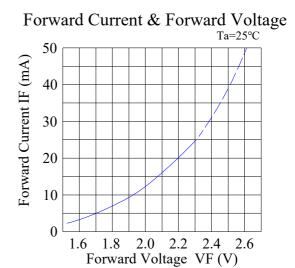
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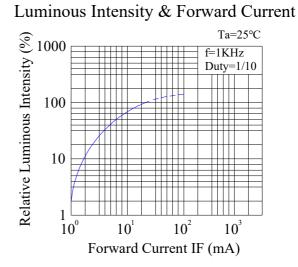
Yellow Green:

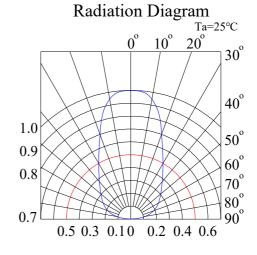


Luminous Intensity & **Ambient Temperature** Relative Luminous Intensity (%) 0001 001 1 -60 -40 -20 0 20 40 60 80 100 Ambient Temperature Ta (°C)









Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%. LTPD: 10%.

1) Test Items and Results:

Test Item	Standard Test Method	Test Conditions Note		Number of Damaged
Resistance to Soldering Heat	JEITA ED-4701 300 302	Tsld=260±5°C, 10sec 3mm from the base of the epoxy bulb	1 time	0/100
Solder ability	JEITA ED-4701 300 303	Tsld=235±5℃, 5sec (using flux)	1time over 95%	0/100
Thermal Shock	JEITA ED-4701 300 307	0°C~100°C 15sec, 15sec	100 cycles	0/100
Temperature Cycle	JEITA ED-4701 100 105	-40°C~25°C~100°C~25°C 30min,5min,30min,5min	100 cycles	0/100
Moisture Resistance Cycle	JEITA ED-4701 200 203	25℃~65℃~-10℃ 90%RH 24hrs/1cycle	10 cycles	0/100
High Temperature Storage	JEITA ED-4701 200 201	Ta=100°C	1000hrs	0/100
Terminal Strength (Pull test)	JEITA ED-4701 400 401	Load 10N (1kgf) 10±1sec		
Terminal Strength (bending test)	JEITA ED-4701 400 401	Load 5N (0.5kgf) 0°~90°~0° bend 2 times	No noticeable damage	0/100
Temperature Humidity Storage	JEITA ED-4701 100 103	Ta=60℃, RH=90%	1000hrs	0/100
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40°C	1000hrs	0/100
Steady State Operating Life		Ta=25℃, IF=30mA	1000hrs	0/100
Steady State Operating Life of High Humidity Heat		Ta=60℃, RH=90%, IF=30mA	500hrs	0/100
Steady State Operating Life of Low Temperature		Ta=-30℃, IF=20mA	1000hrs	0/100

2) Criteria for Judging the Damage:

ltem	Symbol	Test Conditions	Criteria for Judgment	
		lest Conditions	Min.	Max.
Forward Voltage	VF	IF=20mA		F.V.*)×1.1
Reverse Current	IR	VR=5V		F.V.*)×2.0
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7	

*) F.V.: First Value.

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Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30 $^{\circ}$ C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30° C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260° C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

5. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices equipment and machinery must be properly grounded.

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